

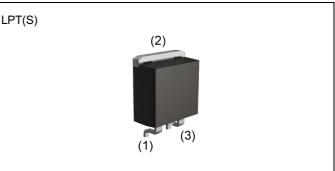
1) Fast reverse recovery time (trr)

4) Drive circuits can be simple

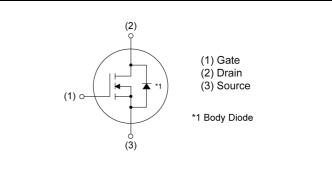
5) Pb-free plating ; RoHS compliant

V _{DSS}	600V
R _{DS(on)} (Max.)	0.234Ω
Ι _D	±20A
P _D	252W

●Outline



Inner circuit



Application

Features

2) Low on-resistance3) Fast switching speed

Switching applications

Packaging specifications

Packing	Embossed Tape
Packing code	TL
Marking	R6020JNJ
Quantity (pcs)	1000

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	600	V
Continuous drain current ($T_c = 25^{\circ}C$)	I _D ^{*1}	±20	А
Pulsed drain current	1 _{DP} *2	±60	А
Gate - Source voltage	V _{GSS}	±30	V
Avalanche current, single pulse	I _{AS} *3	4.8	А
Avalanche energy, single pulse	E _{AS} *3	618	mJ
Power dissipation $(T_c = 25^{\circ}C)$	P _D	252	W
Junction temperature	Tj	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

Thermal resistance

Deremeter	Cumph of	Values			l loit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	0.49	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	80	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

•Electrical characteristics (T_a = 25°C)

Deremeter	Cump of	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		600	-	-	V	
Zero gate voltage drain current	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}C$		-	-	100	μA	
Gate - Source leakage current	I _{GSS}	V _{GS} = ±30V, V _{DS} = 600V	-	-	±100	nA	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 3.5 \text{mA}$	5.0	6.0	7.0	V	
Static drain - source on - state resistance	R _{DS(on)} *5	V_{GS} = 15V, I _D = 10A T _j = 25°C	-	0.180	0.234	Ω	
Gate resistance	R _G	f = 1MHz, open drain	-	2.0	-	Ω	



• Electrical characteristics (T_a = 25°C)

Deremeter	Cump of	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V	-	1500	-	
Output capacitance	C _{oss}	V _{DS} = 100V	-	90	-	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	1.9	-	_
Effective output capacitance energy related	C _{o(er)} *6	V _{GS} = 0V	-	68	-	pF
Effective output capacitance time related	C _{o(tr)} *7	$V_{DS} = 0V$ to 480V	-	270	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 300$ V, V_{GS} = 15V	-	29	-	
Rise time	t _r *5	I _D = 10A	-	22	-	20
Turn - off delay time	$t_{d(off)}^{*5}$	$R_L \simeq 30.1\Omega$	-	56	-	ns
Fall time	t _f *5	R _G = 10Ω	-	13	-	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Cumphal	Conditions	Values			Unit
Parameter	Symbol	Conditions		Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	$V_{DD} \simeq 300 V$	-	45	-	
Gate - Source charge	Q_{gs}^{*5}	I _D = 20A	-	15	-	nC
Gate - Drain charge	${\sf Q}_{\sf gd}{}^{*5}$	V _{GS} = 15V	-	17	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300V$, $I_D = 20A$	-	9.5	-	V

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \simeq 50mH, V_{DD} = 50V, R_G = 25 Ω , starting T_i = 25°C

*4 Tc=25°C

*5 Pulsed

- *6 Co(er) is a fixed capacitance that gives the same stored energy as Coss while V_{DS} is rising from 0 to 80% V_{DSS} .
- *7 Co(tr) is a fixed capacitance that gives the same charging time as Coss while V_{DS} is rising from 0 to 80% V_{DSS} .



•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Source current	I _S *1		-	-	20	A
Pulsed source current	I_{SP}^{*2}	T _C = 25°C	-	-	60	А
Source-Drain voltage	V_{SD}^{*5}	V _{GS} = 0V, I _S = 20A	-	-	1.7	V
Reverse recovery time	t _{rr} *5		-	85	-	ns
Reverse recovery charge	Q _{rr} *5	I _S = 20A di/dt = 100A/μs	-	280	-	nC
Peak reverse recovery current	۱ _{.rr} *5		-	7.5	-	А





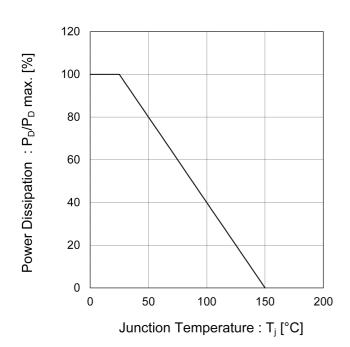


Fig.1 Power Dissipation Derating Curve

Fig.2 Drain Current Derating Curve vs. Junction Temperature

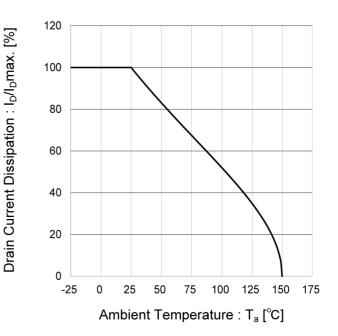


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

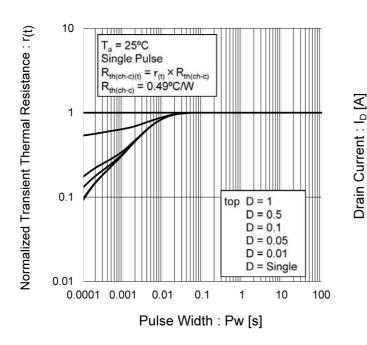
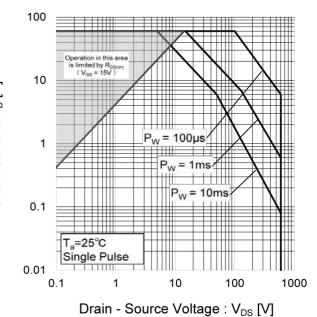


Fig.4 Maximum Safe Operating Area



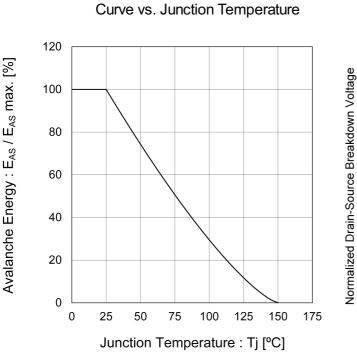
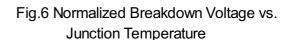


Fig.5 Avalanche Energy Derating



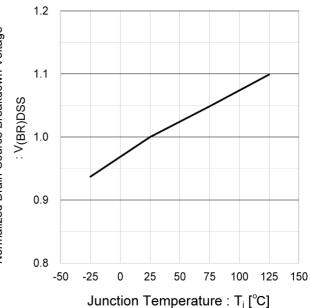


Fig.7 Typical Output Characteristics(I)

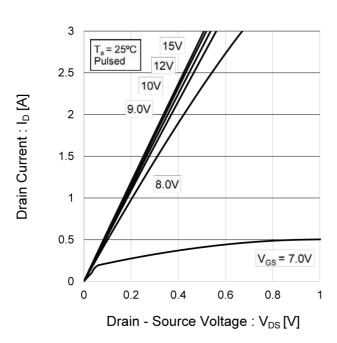
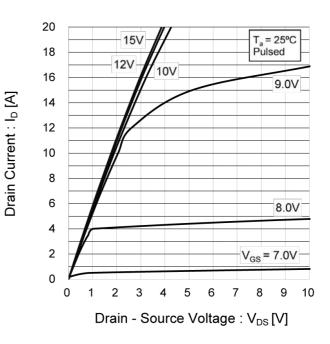


Fig.8 Typical Output Characteristics(II)





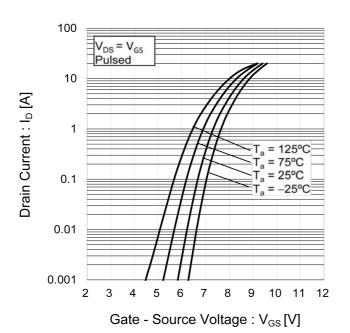


Fig.9 Typical Transfer Characteristics

Fig.10 Normalized Gate Threshold . Voltage vs Junction Temperature

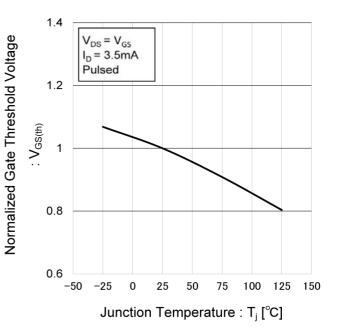
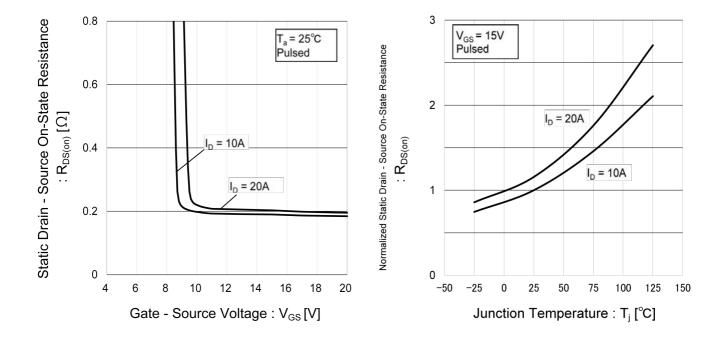


Fig.11 Static Drain - Source On - State Resistance vs. Gate Source Voltage

Fig.12 Normalized Static Drain - Source On - State Resistance vs. Junction Temperature





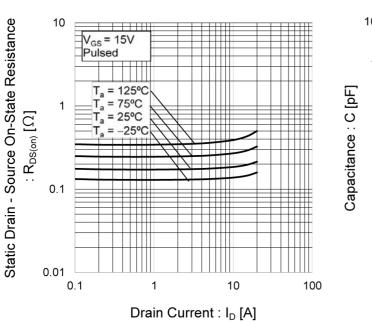


Fig.13 Static Drain - Source On - State

Resistance vs. Drain Current(I)



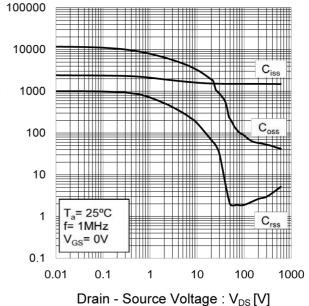
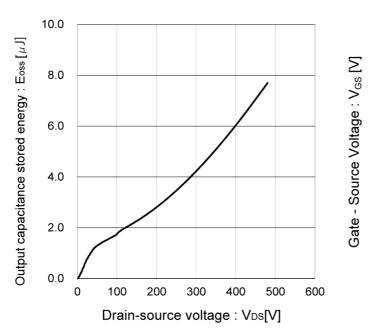
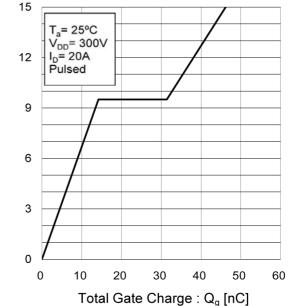


Fig.15 Typical Coss Stored Energy

Fig.16 Dynamic Input Characteristics









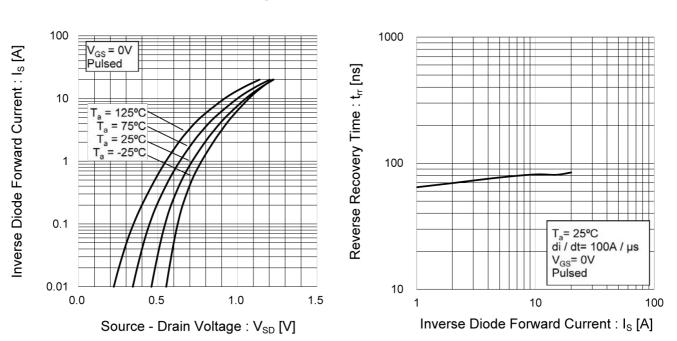
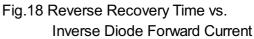


Fig.17 Inverse Diode Forward Current vs. Source - Drain Voltage







Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

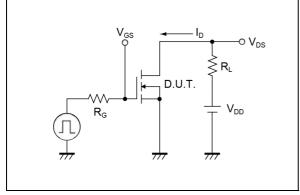


Fig.2-1 Gate Charge Measurement Circuit

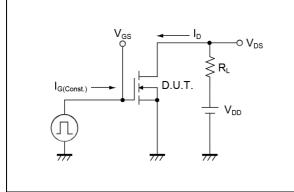


Fig.3-1 Avalanche Measurement Circuit

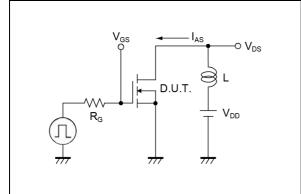


Fig.4-1 Diode Recovery Measurement Circuit

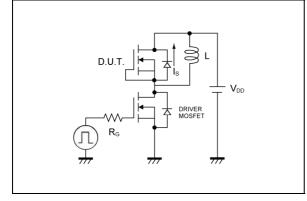


Fig.1-2 Switching Waveforms

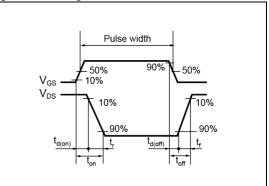


Fig.2-2 Gate Charge Waveform

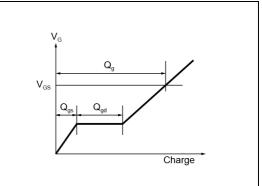


Fig.3-2 Avalanche Waveform

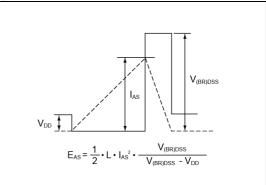
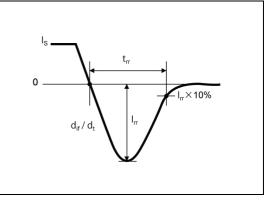
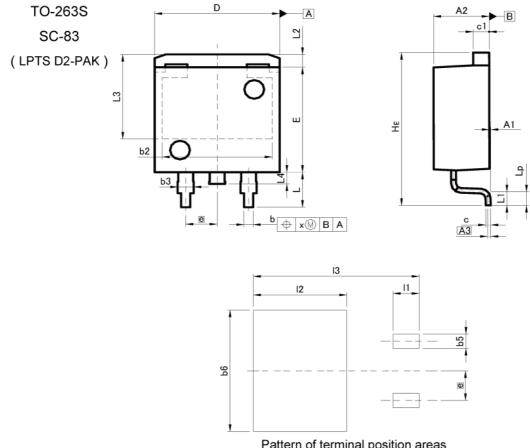


Fig.4-2 Diode Recovery Waveform





Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A1	0.00	0.30	0.000	0.012	
A2	4.30	4.70	0.169	0.185	
A3	0.	25	0.0	10	
b	0.68	0.98	0.027	0.039	
b2	8.	90	0.3	50	
b3	1.14	1.44	0.045	0.057	
C	0.30	0.60	0.012	0.024	
c1	1.10	1.50	0.043	0.059	
D	9.80	10.40	0.386	0.409	
E	8.80	9.20	0.346	0.362	
e	2.	54	0.1	00	
HE	12.80	13.40	0.504	0.528	
L	2.70	3.30	0.106	0.130	
L1	1.	20	0.047		
L2	1.	10	0.043		
L3	7.	25	0.285		
L4	1.	00	0.0	39	
Lp	0.90	1.50	0.035	0.059	
x	Z .	0.25		0.010	
	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
b5	.	1.23	-	0.049	
b6		10.40		0.409	
11	<u></u>	2.10	1 <u>111</u>	0.083	
12		7.55	1. 1.	0.297	
13		13.40		0.528	

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
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CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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